L Numbe	r Hit			
•		3 5497291.pn.	DB	Time stamp
	.]		USPAT;	2001/12/05 15.
	1		US-PGPUB	
	İ		ЕРО; ЛРО;	'
	Í		DERWENT	.
-	-	3 3771101.pn.	IBM TDB	']
		77.1101.pm.	USPAT:	2001/12/05 11
			US-PGPUB;	2001/12/05 11: 2
	ľ		EPO; JPO;	
	1		DERWENT;	
-	١,	5205044	IBM TDB	
	3	5295044.pn.	I I I I I I I I I I I I I I I I I I I	
	l		USPAT;	2001/12/05 11: 2
			US-PGPUB,	
	İ		ЕРО; ЈРО;	1
	1		DERWENT,	
•	7	5295044.URPN.	IBM TDB	
	j		USPAT;	2001/12/05 11: 3
			US-PGPUB;	
			EPO; JPO:	
	1		DERWENT;	
	18	("4356532" "4956746" 1//496906 (1/) 1//505707	IBM TDB	
]	("4356532" "4956746" "4969066" "5057971" "5101322" "5172303").PN.	USPAT:	2001/12/05 11: 3
	ĺ		US-PGPUB;	2001/12/05 11: 5
			ЕРО; ЛРО;	
	ļ		DERWENT;	1
	6	5407301 HDDNI	IBM TDB	Ì
	,	5497291.URPN.	USPAT:	3001.13.05
	1		US-PGPUB;	2001/12/05 11:43
	ļ		EDO TOO	
			EPO; JPO;	
			DERWENT;	
	6	5497291.URPN.	IBM TDB	
			USPAT;	2001/12/05 11:47
1			US-PGPUB;	
ļ			EPO; JPO;	
}	ł		DERWENT,	
	3	"5382830".PN.	IBM TDB	
			USPAT;	2001/12/05 11:47
	1		US-PGPUB;	
	1		EPO; JPO;	
	ŀ		DERWENT;	
	2	6178095.pn.	IBM TDB	
-	- }		USPAT;	2001/12/05 16:42
i	i		US-PGPUB;	
	1		EPO; JPO;	
1	- 1		DERWENT;	
1	440	oluminum and all the	IBM TDB	
İ	448	aluminum and gold near(wire near bonds3)	V. C	3001.43.45
1			IIS-DCDID	2001/12/05 16:44
İ	j		US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
			IBM TDB	

L Number			DB Time stamp	5
-	1401	361/736	USPAT; 2001/12/03	11:47
	1		US-PGPUB;	
			EPO; JPO; DERWENT;	
			IBM TDB	
-	332	361/736 and (ceramic or epoxy)	USPAT; 2001/11/29 1	14.3/
			US-PGPUB;	(
			ЕРО; ЈРО;	
			DERWENT;	
-	273	361/719.ccls. and (ceramic or epoxy)	IBM TDB	
	2,3	3017/17.ccis. and (ceramic of epoxy)	USPAT; 2001/11/29 I US-PGPUB;	14: 52
			ЕРО; ЛРО;	
	1		DERWENT;	
			IBM TDB	
•	124	361/720.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	14: 57
			US-PGPUB;	
	İ		EPO, JPO,	
			DERWENT;	
•	35	361/739.ccls. and (ceramic or epoxy)	IBM TDB	
		50277 57. cels. and teermine of epoxy)	USPAT;	.5: 01
			EPO; JPO;	
			DERWENT;	
			IBM TDB	
	140	361/752.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	15:12
			US-PGPUB;	
			EPO; JPO;	
			DERWENT;	
	14	3/1/7/2 cole and (coromic or anoun)	IBM TDB	
	14	361/742.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	5:14
			US-PGPUB;	
	<u> </u>		EPO; JPO; DERWENT;	
	[[IBM TDB	
-	176	361/784.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	5 - 21
		• •	US-PGPUB;	
	<u> </u>		EPO; JPO;	
			DERWENT,	
			IBM TDB	
	121	361/785.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	5:25
			US-PGPUB;	
			EPO, JPO;	
			DERWENT; IBM TDB	
	36	361/789.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	5. 20
		The second and total and or oponly to	US-PGPUB:	3: 27
			EPO; JPO;	
	i		DERWENT;	
			IBM TDB	
	102	361/790.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 1	5: 33
			US-PGPUB;	
			EPO; JPO;	
	İ		DERWENT;	
	32	361/791.ccls. and (ceramic or epoxy)	IBM TDB	E. 20
		records and tooranne or epoxy	USPAT;): 5 8
			EPO; JPO;	
-			DERWENT:	
1			IBM TDB	
ŀ	202	361/772.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 15	5:42
			US-PGPUB;	
			EPO; JPO;	
İ			DERWENT;	
	,,,	3/1/773 cole and /companies =======	IBM TDB	_
	152	361/773.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 15	j: 45
			US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
	204	361/774.ccls. and (ceramic or epoxy)	USPAT; 2001/11/29 15	
	.07	TOS	US-PGPUB; 2001/11/29 15): ዣቻ
]		EPO; JPO;	
	[DERWENT;	
			, — —··—-·· — ,	

•	130	361/803.ccls. and (ceramic or epoxy)	TYION M	
	130	3517603.ccis. and (ceramic of epoxy)	USPAT;	2001/11/29 15: 52
			US-PGPUB; EPO; JPO;	İ
	1		DERWENT;	į
	1		IBM TDB	
-	19	361/804.ccls. and (ceramic or epoxy)	USPAT;	2001/11/29 15:53
İ			US-PGPUB,	
İ	1		EPO; JPO;	
1	l		DERWENT;	
-	515	174/52.2.ccls. and (ceramic or epoxy)	IBM TDB	
	313	1747 32.2.ccis. and (ceramic of epoxy)	USPAT;	2001/11/29 15: 54
	j		US-PGPUB,	
	1		EPO; JPO; DERWENT;	
1			IBM TDB	
-	165	174/52.2.ccls. and (ceramic or epoxy) and (pins or connectors)	USPAT:	2001/11/29 16:01
			US-PGPUB;	2002/11/2/10:01
			EPO; JPO;	
			DERWENT:	
		landar de la companya	IBM TDB	
] -	334	174/52.4.ccls. and (ceramic or epoxy) and (pins or connectors)	USPAT;	2001/11/29 16:42
			US-PGPUB;	
	1		EPO; JPO;	
			DERWENT;	
-	6230	power near module	IBM TDB	
	0250	power near module	USPAT;	2001/11/29 16:05
	ŀ		US-PGPUB; EPO; JPO;	
	Ì		DERWENT;	
		•	IBM TDB	
-	1046	power near module and pins	USPAT;	2001/11/29 16: 26
ļ		•	US-PGPUB;	2002/12/2/ 10:20
			EPO; JPO;	
			DERWENT;	
ŀ		420,020 cale and (assessing a second of the s	IBM TDB	
-	,	439/928.ccls. and (ceramic or epoxy) and (pins or connectors)	USPAT;	2001/11/29 16:44
1	j		US-PGPUB;	
			EPO; JPO;	
			DERWENT; IBM TDB	
-	2	439/928.1.ccls. and (ceramic or epoxy) and (pins or connectors)	USPAT;	2001/11/29 16:44
1		tpillo of conflictions	US-PGPUB:	2001/11/27 10:44
	ļ		EPO; JPO;	
			DERWENT;	
			IBM TDB	
-	87	439/928.1.ccls.	USPAT;	2001/11/29 16:46
			US-PGPUB;	1
	ļ		EPO; JPO;	i
			DERWENT;	
-	153	439/928.ccls.	IBM TDB USPAT:	2001/11/2017 50
			US-PGPUB:	2001/11/29 16:50
ļ			EPO; JPO;	
			DERWENT:	
			IBM TDB	
-	701	257/691.ccls.	USPAT;	2001/11/29 16:51
			US-PGPUB;	
·			EPO; JPO;) - \ i
	İ		DERWENT;	i
	_	W/17000F:	IBM TDB	
-	2	"6178095"	USPAT;	2001/11/29 16:57
			US-PGPUB;	İ
	į		EPO; JPO;	Į
ĺ			DERWENT;	
<u></u> .			IBM TDB	